

# **Smart Highside High Current Power Switch**

#### **Features**

- Overload protection
- Current limitation
- Short circuit protection
- Overtemperature protection
- Overvoltage protection (including load dump)
- · Clamp of negative voltage at output
- Fast deenergizing of inductive loads 1)
- Low ohmic inverse current operation
- Reverse battery protection
- · Diagnostic feedback with load current sense
- Open load detection via current sense
- Loss of V<sub>bb</sub> protection<sup>2)</sup>
- Electrostatic discharge (ESD) protection

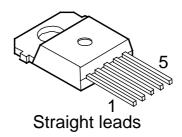
### **Application**

- Power switch with current sense diagnostic feedback for 12 V and 24 V DC grounded loads
- Most suitable for loads with high inrush current like lamps and motors; all types of resistive and inductive loads
- Replaces electromechanical relays, fuses and discrete circuits

### **Product Summary**

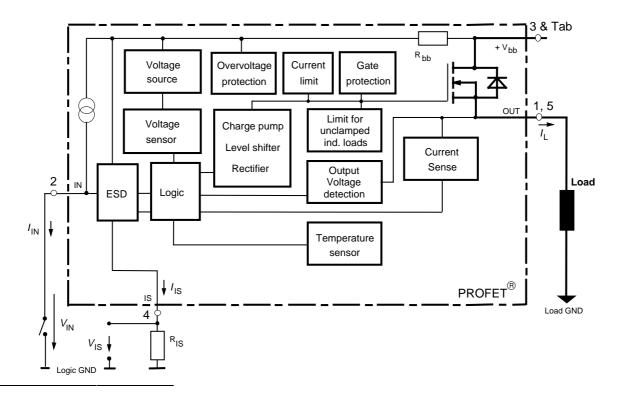
Overvoltage protection	V <sub>bb(AZ)</sub>	63	V
Output clamp	$V_{ON(CL)}$	42	V
Operating voltage	$V_{ m bb(on)}$	5.0 34	V
On-state resistance	RON	4.0	$m\Omega$
Load current (ISO)	<i>I</i> L(ISO)	97	Α
Short circuit current limitation	<i>I</i> L(SCp)	180	Α
Current sense ratio	<i>I</i> L: <i>I</i> IS	21000	

TO-218AB/5



### **General Description**

N channel vertical power FET with charge pump, current controlled input and diagnostic feedback with load current sense, integrated in Smart SIPMOS® chip on chip technology. Fully protected by embedded protection functions.



<sup>1)</sup> With additional external diode.

<sup>2)</sup> Additional external diode required for energized inductive loads (see page 8).



Pin	Symbol		Function
1	OUT	0	Output to the load. The pins 1 and 5 must be shorted with each other especially in high current applications! <sup>3)</sup>
2	IN	I	Input, activates the power switch in case of short to ground
3	Vbb	+	Positive power supply voltage, the tab is electrically connected to this pin. In high current applications the tab should be used for the $V_{bb}$ connection instead of this pin <sup>4</sup> ).
4	IS	S	Diagnostic feedback providing a sense current proportional to the load current; zero current on failure (see Truth Table on page 6)
5	OUT	0	Output to the load. The pins 1 and 5 must be shorted with each other especially in high current applications! <sup>3)</sup>

## **Maximum Ratings** at $T_j = 25$ °C unless otherwise specified

Parameter	Symbol	Values	Unit
Supply voltage (overvoltage protection see page 4)	$V_{ m bb}$	42	V
Supply voltage for full short circuit protection, $T_{j,\text{start}}$ =-40+150°C:	$V_{ m bb}$	34	V
Load current (short circuit current, see page 4)	<b>/</b> ∟	self-limited	Α
Load dump protection $V_{LoadDump} = U_A + V_S$ , $U_A = 13.5 \text{ V}$			_
$R_1^{(5)} = 2 \Omega$ , $R_L = 0.54 \Omega$ , $t_d = 200 \text{ms}$ ,	V <sub>Load dump</sub> 6)	90	V
IN, IS = open or grounded			
Operating temperature range	T <sub>j</sub>	-40+150	°C
Storage temperature range	$T_{ m stg}$	-55+150	
Power dissipation (DC), T <sub>C</sub> ≤ 25 °C	$P_{\text{tot}}$	360	W
Inductive load switch-off energy dissipation, single pulse $V_{bb} = 12V$ , $T_{j,start} = 150$ °C, $T_{C} = 150$ °C const., $I_{L} = 20$ A, $Z_{L} = 15$ mH, $0\Omega$ , see diagrams on page 9	E <sub>AS</sub>	3	J
Electrostatic discharge capability (ESD) Human Body Model acc. MIL-STD883D, method 3015.7 and ESD assn. std. S5.1-1993, C = 100 pF, R = 1.5 k $\Omega$	V <sub>ESD</sub>	4	kV
Current through input pin (DC)	I <sub>IN</sub>	+15, -250	mA
Current through current sense status pin (DC)	I <sub>IS</sub>	+15, -250	
see internal circuit diagrams on page 6 and 7			

<sup>3)</sup> Not shorting all outputs will considerably increase the on-state resistance, reduce the peak current capability and decrease the current sense accuracy

Otherwise add up to 0.5 m $\Omega$  (depending on used length of the pin) to the R<sub>ON</sub> if the pin is used instead of the tab

 $R_{\rm I}$  = internal resistance of the load dump test pulse generator.

<sup>6)</sup> V<sub>Load dump</sub> is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839.



### **Thermal Characteristics**

Parameter and Conditions		Symbol	Values			Unit
			min	typ	max	
Thermal resistance	chip - case:	$R_{\mathrm{thJC}^{7}}$			0.35	K/W
	junction - ambient (free air):	$R_{thJA}$		30		

### **Electrical Characteristics**

Parameter and Conditions	Symbol	Values		Unit	
at $T_j = -40 \dots +150$ °C, $V_{bb} = 12$ V unless otherwise specified		min	typ	max	

### **Load Switching Capabilities and Characteristics**

On-state resistance (Tab to pins 1,5, see measurement					
circuit page 6) $I_L = 20 \text{ A}, T_j = 25 \text{ °C}$	011		3.3	4.0	$m\Omega$
$V_{IN} = 0$ , $I_L = 20 \text{ A}$ , $T_j = 150 ^{\circ}\text{C}$			6.4	7.8	
$I_{L} = 120 \text{ A}, T_{j} = 150 ^{\circ}\text{C}$				8	
$V_{bb} = 6V^{8}$ , $I_{L} = 20 \text{ A}$ , $T_{j} = 150 ^{\circ}\text{C}$	$R_{ON(Static)}$		9	12	
Nominal load current <sup>9)</sup> (Tab to pins 1,5)	I <sub>L(ISO)</sub>	80	97		Α
ISO 10483-1/6.7: $V_{ON} = 0.5 \text{V}$ , $T_{C} = 85 ^{\circ}\text{C}$ <sup>10)</sup>					
Maximum load current in resistive range					
(Tab to pins 1,5) $V_{ON} = 1.8  \text{V},  T_{C} = 25  ^{\circ}\text{C}$	I <sub>L(Max)</sub>	350			
see diagram on page 12 $V_{ON} = 1.8 \text{ V}, T_{C} = 150 ^{\circ}\text{C}$		180			Α
Turn-on time <sup>11)</sup> I <sub>IN</sub> I <sub>IN</sub> to 90% V <sub>OUT</sub>	<i>t</i> on	140		600	μs
Turn-off time $I_{IN} \perp$ to 10% $V_{OUT}$	$t_{ m off}$	40		150	
$R_L = 1 \Omega$ , $T_j = -40 + 150$ °C					
Slew rate on $^{11)}$ (10 to 30% $V_{OUT}$ )	d V/dt <sub>on</sub>		0.45		V/μs
$R_L = 1 \Omega$ , $T_j = 25$ °C					
Slew rate off <sup>11)</sup> (70 to 40% $V_{OUT}$ )	-dV/dt <sub>off</sub>		0.55		V/μs
$R_L = 1 \Omega$ , $T_j = 25$ °C					

## **Inverse Load Current Operation**

On-state resistance (Pins 1,5 to pin 3)						
$V_{\text{bIN}} = 12 \text{ V}, I_{\text{L}} = -20 \text{ A}$	$T_j = 25 ^{\circ}\text{C}$ :	$R_{ m ON(inv)}$		3.3	4.0	mΩ
see diagram on page 9	$T_{j} = 150 ^{\circ}\text{C}$ :			6.4	7.8	
Nominal inverse load current (Pins 1,5 to	Tab)	I <sub>L(inv)</sub>	80	97		Α
$V_{ON} = -0.5 \text{V}, \ T_{C} = 85 ^{\circ}\text{C}^{10}$						
Drain-source diode voltage ( $V_{out} > V_{bb}$ ) $I_L = -20 \text{ A}$ , $I_{IN} = 0$ , $T_j = +150 ^{\circ}\text{C}$		-V <sub>ON</sub>		8.0		V

 $<sup>^{7)}</sup>$  Thermal resistance  $R_{\text{thCH}}$  case to heatsink (about 0.25 K/W with silicone paste) not included!

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B) Decrease of  $V_{bb}$  below 10 V causes a slowly a dynamic increase of  $R_{ON}$  to a higher value of  $R_{ON(Static)}$ . As long as  $V_{bIN} > V_{bIN(u) \text{ max}}$ ,  $R_{ON}$  increase is less than 10 % per second for  $T_J < 85$  °C.

<sup>9)</sup> Not tested, specified by design.

 $T_{\rm J}$  is about 105°C under these conditions.

<sup>11)</sup> See timing diagram on page 13.

Parameter and Conditions	Symbol	Values		Unit	
at $T_j = -40 \dots +150 ^{\circ}\text{C}$ , $V_{bb} = 12 ^{\circ}\text{V}$ unless otherwise specified		min	typ	max	

### **Operating Parameters**

Operating voltage $(V_{IN} = 0)^{8}$	12)	$V_{ m bb(on)}$	5.0		34	V
Undervoltage shutdown 13)		$V_{bIN(u)}$	2.0	3.0	4.5	V
Undervoltage start of charge see diagram page 14	pump	$V_{ m blN(ucp)}$	3.5	4.5	6.0	V
Overvoltage protection <sup>14)</sup>	<i>T</i> <sub>j</sub> =-40°C:	$V_{bIN(Z)}$	60			V
$I_{bb} = 15 \mathrm{mA}$	$T_{\rm j}$ = 25+150°C:		62	66		
Standby current	<i>T</i> <sub>j</sub> =-40+25°C:	I <sub>bb(off)</sub>		15	25	μΑ
$I_{IN} = 0$	$T_{\rm j} = 150^{\circ}{\rm C}$ :			25	50	

### **Protection Functions**

I <sub>L(SCp)</sub>		170		Α
		180	250	
	120	170		
$t_{\sf d(SC)}$	80		350	μs
- V <sub>OUT(CL)</sub>		16.8 19.0		V
V <sub>ON(CL)</sub>	39	42	46.5	V
$V_{ m ON(SC)}$		6		V
$T_{jt}$	150			°C
$\Delta T_{\rm jt}$		10		K
	$t_{d(SC)}$ $-V_{OUT(CL)}$ $V_{ON(CL)}$ $V_{ON(SC)}$ $T_{jt}$	td(SC)   80   -Vout(CL)	180 120 170 td(SC) 80 16.8 19.0  V <sub>ON(CL)</sub> 39 42  V <sub>ON(SC)</sub> 6  T <sub>jt</sub> 150	180 250 120 170  td(SC) 80 350  16.8 19.0  VON(CL) 39 42 46.5  T <sub>jt</sub> 150

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<sup>&</sup>lt;sup>12)</sup> If the device is turned on before a  $V_{bb}$ -decrease, the operating voltage range is extended down to  $V_{blN(u)}$ . For the voltage range 0..34 V the device is fully protected against overtemperature and short circuit.

<sup>13)</sup>  $V_{bIN} = V_{bb} - V_{IN}$  see diagram on page 6. When  $V_{bIN}$  increases from less than  $V_{bIN(u)}$  up to  $V_{bIN(ucp)} = 5 V$  (typ.) the charge pump is not active and  $V_{OUT} \approx V_{bb} - 3 V$ .

<sup>&</sup>lt;sup>14)</sup> See also *V*<sub>ON(CL)</sub> in circuit diagram on page 7.

This output clamp can be "switched off" by using an additional diode at the IS-Pin (see page 7). If the diode is used, V<sub>OUT</sub> is clamped to V<sub>bb</sub>- V<sub>ON(CL)</sub> at inductive load switch off.

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Syllibol	Values			Offic
	min	typ	max	
- V <sub>bb</sub>			32	V
R <sub>ON(rev)</sub>		3.8	4.6	mΩ
, ,			9	
R <sub>bb</sub>		120		Ω
•	· · · · · · · · · · · · · · · · · · ·			
	R <sub>ON(rev)</sub>	min -V <sub>bb</sub>	min typ  - V <sub>bb</sub> R <sub>ON(rev)</sub> 3.8	min typ max  -V <sub>bb</sub> 32  R <sub>ON(rev)</sub> 3.8 4.6 9

### **Diagnostic Characteristics**

$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Diagnostis Characteristics						
Sense current saturation $I_{IS,lim}$ 6.5           mA           Current sense leakage current $I_{IN} = 0$ , $V_{IS} = 0$ : $I_{IS(LL)}$ 0.5         μA $V_{IN} = 0$ , $V_{IS} = 0$ , $I_{L} \le 0$ : $I_{IS(LH)}$ 2            Current sense settling time <sup>18</sup> $t_{S(IS)}$ 500         μs           Overvoltage protection $T_j = -40$ °C: $V_{bIS(Z)}$ 60           V	static on-condition, $k_{\text{ILIS}} = I_{\text{L}} : I_{\text{IS}},$ $V_{\text{ON}} < 1.5  \text{V}^{17},$ $V_{\text{IS}} < V_{\text{OUT}} - 5  \text{V},$ $V_{\text{bIN}} > 4.0  \text{V}$	$T_{i} = 25^{\circ}\text{C}$ : $T_{j} = 150^{\circ}\text{C}$ : $I_{L} = 20 \text{ A}, T_{j} = -40^{\circ}\text{C}$ : $T_{i} = 25^{\circ}\text{C}$ : $T_{i} = 150^{\circ}\text{C}$ : $I_{L} = 12 \text{ A}, T_{j} = -40^{\circ}\text{C}$ : $T_{j} = 25^{\circ}\text{C}$ : $T_{i} = 150^{\circ}\text{C}$ : $I_{L} = 6 \text{ A}, T_{j} = -40^{\circ}\text{C}$ : $T_{j} = 25^{\circ}\text{C}$ :	<i>k</i> <sub>ILIS</sub>	19 000 18 400 19 300 19 500 18 500 19 000 19 000 17 500 17 000 17 000	20 900 19 600 22 500 21 500 20 500 23 000 22 500 20 000 26 000 23 800	22 500 22 000 25 500 24 800 23 000 27 500 26 000 22 000 42 000 33 000	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$I_{IS}=0$ by $I_{IN}=0$ (e.g. during deen						
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Sense current saturation	I <sub>IS,lim</sub>	6.5			mA	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Current sense leakage curre						
Current sense settling time $^{18}$ $t_{s(IS)}$ 500 $\mu s$ Overvoltage protection $T_j = -40^{\circ}C$ : $V_{bIS(Z)}$ 60V	_	$I_{IN} = 0$ , $V_{IS} = 0$ :	I <sub>IS(LL)</sub>			0.5	μΑ
Overvoltage protection $T_j = -40^{\circ}\text{C}$ : $V_{\text{bIS}(Z)}$ 60 V		$V_{\text{IN}} = 0$ , $V_{\text{IS}} = 0$ , $I_{\text{L}} \le 0$ :	I <sub>IS(LH)</sub>		2		
7) 10 01 Pblo(2)	Current sense settling time18	$t_{\rm s(IS)}$			500	μs	
$I_{bb} = 15 \text{ mA}$ $T_j = 25+150 ^{\circ}\text{C}$ : 62 66	Overvoltage protection	<i>T</i> <sub>j</sub> =-40°C:	$V_{bIS(Z)}$	60			V
	$I_{bb} = 15 \mathrm{mA}$	$T_{\rm j}$ = 25+150°C:		62	66		

## Input

Input and operating current (see diagram page 12) IN grounded (V <sub>IN</sub> = 0)	I <sub>IN(on)</sub>	 0.8	1.5	mA
Input current for turn-off <sup>19)</sup>	I <sub>IN(off)</sub>	 -	80	μΑ

Semiconductor Group

The reverse load current through the intrinsic drain-source diode has to be limited by the connected load (as it is done with all polarity symmetric loads). Note that under off-conditions ( $I_{|N} = I_{|S} = 0$ ) the power transistor is not activated. This results in raised power dissipation due to the higher voltage drop across the intrinsic drain-source diode. The temperature protection is not active during reverse current operation! Increasing reverse battery voltage capability is simply possible as described on page 8.

<sup>&</sup>lt;sup>17)</sup> If  $V_{ON}$  is higher, the sense current is no longer proportional to the load current due to sense current saturation, see  $I_{IS.lim}$ .

<sup>&</sup>lt;sup>18)</sup> Not tested, specified by design.

We recommend the resistance between IN and GND to be less than 0.5 k $\Omega$  for turn-on and more than 500k $\Omega$  for turn-off. Consider that when the device is switched off (I<sub>IN</sub> = 0) the voltage between IN and GND reaches almost V<sub>bb</sub>.



Preliminary Data Sheet BTS550P

Parameter and Conditions	Symbol		Values	;	Unit
at $T_j = -40 \dots +150$ °C, $V_{bb} = 12$ V unless otherwise specified		min	typ	max	

### **Truth Table**

	Input current	Output	Current Sense	Remark
	level	level	lis	
Normal	L	L	0	
operation	Н	Н	nominal	=I <sub>L</sub> / k <sub>ilis</sub> , up to I <sub>IS</sub> =I <sub>IS,lim</sub>
Very high load current	Н	Н	I <sub>IS, lim</sub>	up to V <sub>ON</sub> =V <sub>ON(Fold back)</sub> I <sub>IS</sub> no longer proportional to I <sub>L</sub>
Current- limitation	н	Н	0	V <sub>ON</sub> > V <sub>ON(Fold back)</sub> if V <sub>ON</sub> >V <sub>ON(SC)</sub> , shutdown will occure
Short circuit to	L	L	0	
GND	Н	L	0	
Over-	L	L	0	
temperature	Н	L	0	
Short circuit to	L	Н	0	
$V_{bb}$	H	Н	<nominal <sup="">20)</nominal>	
Open load	L	<b>Z</b> <sup>21</sup> )	0	
	Н	Н	0	
Negative output voltage clamp	L	L	0	
Inverse load	L	Н	0	
current	Н	Н	0	

L = "Low" Level

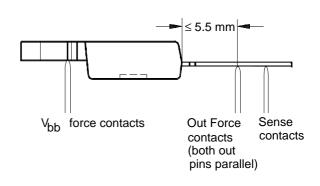
H = "High" Level

Overtemperature reset by cooling:  $T_{j} < T_{jt}$  (see diagram on page 14)

Short circuit to GND: Shutdown remains latched until next reset via input (see diagram on page 13)

### **Terms** |I<sub>bb</sub> $V_{bIN}$ $V_{ON}$ $V_{\mathsf{bb}}$ IN **PROFET** IS VI<sub>IS</sub> V<sub>bIS</sub> $D_{S}$ $V_{OUT}$ $\mathsf{R}_{\mathsf{IS}}$ V<sub>IS</sub> Two or more devices can easily be connected in parallel to increase load current capability.

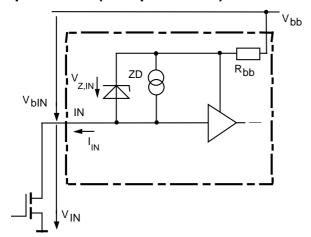
# **RON** measurement layout



Low ohmic short to  $V_{\rm bb}$  may reduce the output current  $I_{\rm L}$  and can thus be detected via the sense current  $I_{\rm IS}$ .

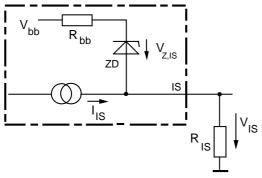
<sup>&</sup>lt;sup>21)</sup> Power Transistor "OFF", potential defined by external impedance.

### Input circuit (ESD protection)



When the device is switched off ( $I_{IN} = 0$ ) the voltage between IN and GND reaches almost  $V_{bb}$ . Use a mechanical switch, a bipolar or MOS transistor with appropriate breakdown voltage as driver.  $V_{Z,IN} = 66 \text{ V}$  (typ).

### **Current sense status output**



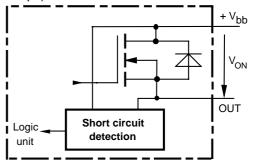
 $V_{\rm Z,IS} = 66 \, {\rm V}$  (typ.),  $R_{\rm IS} = 1 \, {\rm k}\Omega$  nominal (or  $1 \, {\rm k}\Omega$  /n, if n devices are connected in parallel).  $I_{\rm S} = I_{\rm L}/k_{\rm ilis}$  can be driven only by the internal circuit as long as  $V_{\rm out}$  -  $V_{\rm IS} > 5 \, {\rm V}$ . If you want to measure load currents up to  $I_{\rm L(M)}$ ,

R<sub>IS</sub> should be less than  $\frac{V_{\rm bb}$  - 5 V  $I_{\rm L(M)}$  /  $I_{\rm Kilis}$ .

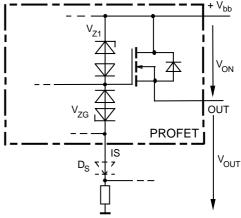
Note: For large values of  $R_{\rm IS}$  the voltage  $V_{\rm IS}$  can reach almost  $V_{\rm bb}$ . See also overvoltage protection. If you don't use the current sense output in your application, you can leave it open.

### **Short circuit detection**

Fault Condition:  $V_{ON} > V_{ON(SC)}$  (6 V typ.) and t>  $t_{d(SC)}$  (80 ...350 µs).

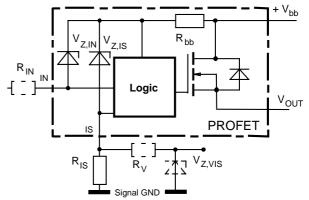


### Inductive and overvoltage output clamp



 $V_{ON}$  is clamped to  $V_{ON(Cl)} = 42\,V$  typ. At inductive load switch-off without  $D_S,~V_{OUT}$  is clamped to  $V_{OUT(CL)} = -19\,V$  typ. via  $V_{ZG}.$  With  $D_S,~V_{OUT}$  is clamped to  $V_{bb}$ -  $V_{ON(CL)}$  via  $V_{Z1}.$  Using  $D_S$  gives faster deenergizing of the inductive load, but higher peak power dissipation in the PROFET.

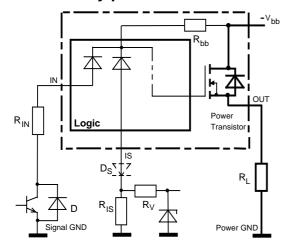
### Overvoltage protection of logic part



 $R_{bb}$  = 120  $\Omega$  typ.,  $V_{Z,IN}$  =  $V_{Z,IS}$  = 66 V typ.,  $R_{IS}$  = 1 k $\Omega$  nominal. Note that when overvoltage exceeds 71 V typ. a voltage above 5V can occur between IS and GND, if  $R_{V},\,V_{Z,VIS}$  are not used.



### **Reverse battery protection**



 $R_V \ge 1 \text{ k}\Omega$ ,  $R_{IS} = 1 \text{ k}\Omega$  nominal. Add  $R_{IN}$  for reverse battery protection in applications with  $V_{bb}$  above

16 V<sup>16)</sup>; recommended value: 
$$\frac{1}{R_{IN}} + \frac{1}{R_{IS}} + \frac{1}{R_{V}} =$$

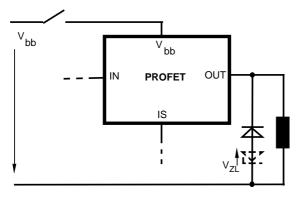
$$\frac{0.1\text{A}}{|V_{bb}| - 12\text{V}}$$
 if D<sub>S</sub> is not used (or  $\frac{1}{R_{IN}} = \frac{0.1\text{A}}{|V_{bb}| - 12\text{V}}$  if D<sub>S</sub> is used).

To minimize power dissipation at reverse battery operation, the summarized current into the IN and IS pin should be about 120mA. The current can be provided by using a small signal diode D in parallel to the input switch, by using a MOSFET input switch or by proper adjusting the current through  $R_{\rm IS}$  and  $R_{\rm V}$ .

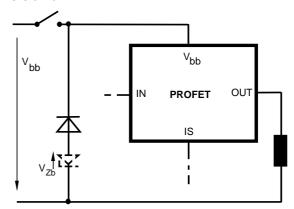
# V<sub>bb</sub> disconnect with energized inductive load

Provide a current path with load current capability by using a diode, a Z-diode, or a varistor. ( $V_{\rm ZL}$  < 72 V or  $V_{\rm Zb}$  < 30 V if R<sub>IN</sub>=0). For higher clamp voltages currents at IN and IS have to be limited to 250 mA.

Version a:

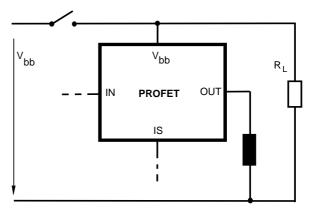


Version b:

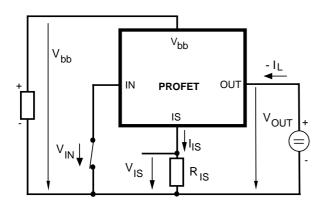


Note that there is no reverse battery protection when using a diode without additional Z-diode  $V_{ZL}$ ,  $V_{Zb}$ .

Version c: Sometimes a neccessary voltage clamp is given by non inductive loads  $R_{\text{L}}$  connected to the same switch and eliminates the need of clamping circuit:



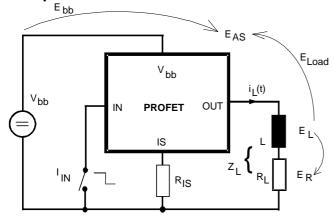
### **Inverse load current operation**



The device is specified for inverse load current operation ( $V_{\rm OUT} > V_{\rm bb} > 0V$ ). The current sense feature is not available during this kind of operation ( $I_{\rm IS} = 0$ ). With  $I_{\rm IN} = 0$  (e.g. input open) only the intrinsic drain source diode is conducting resulting in considerably increased power dissipation. If the device is switched on ( $V_{\rm IN} = 0$ ), this power dissipation is decreased to the much lower value  $R_{\rm ON(INV)} * P_{\rm IN} = 0$  (specifications see page 3).

Note: Temperature protection during inverse load current operation is not possible!

# Inductive load switch-off energy dissipation



Energy stored in load inductance:

$$E_L = \frac{1}{2} \cdot L \cdot I_L^2$$

While demagnetizing load inductance, the energy dissipated in PROFET is

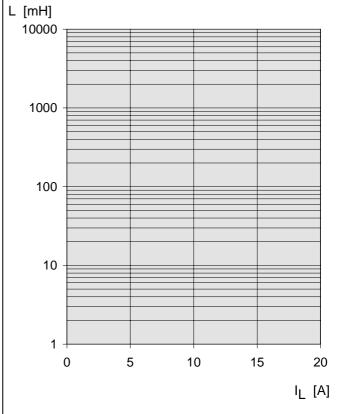
$$E_{AS} = E_{bb} + E_L - E_R = \int V_{ON(CL)} \cdot i_L(t) dt$$

with an approximate solution for  $R_L > 0 \Omega$ :

$$E_{\text{AS}} = \frac{I_{\text{L}} \cdot L}{2 \cdot R_{\text{L}}} (V_{\text{bb}} + |V_{\text{OUT(CL)}}|) \ ln \ (1 + \frac{I_{\text{L}} \cdot R_{\text{L}}}{|V_{\text{OUT(CL)}}|})$$

# Maximum allowable load inductance for a single switch off

$$L = f(\bar{I_L})$$
;  $T_{j,start} = 150$ °C,  $V_{bb} = 12$  V,  $R_L = 0$   $\Omega$ 





### **Options Overview**

Type BTS	550P 650P	555
Overtemperature protection with hysteresis	Χ	Χ
T <sub>j</sub> >150 °C, latch function <sup>22)</sup>		Χ
$T_{j}$ >150 °C, with auto-restart on cooling	Χ	
Short circuit to GND protection		
switches off when $V_{\rm ON}>6$ V typ. (when first turned on after approx. 180 $\mu$ s)	Х	Χ
Overvoltage shutdown	-	-
Output negative voltage transient limit		
to V <sub>bb</sub> - V <sub>ON(CL)</sub>	X	X
to $V_{OUT} = -19 \text{ V typ}$	X <sup>23)</sup>	χ23)

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Latch except when  $V_{\rm bb}$  - $V_{\rm OUT}$  <  $V_{\rm ON(SC)}$  after shutdown. In most cases  $V_{\rm OUT}$  = 0 V after shutdown ( $V_{\rm OUT}$   $\neq$  0 V only if forced externally). So the device remains latched unless  $V_{\rm bb}$  <  $V_{\rm ON(SC)}$  (see page 4). No latch between turn on and  $t_{\rm d(SC)}$ .

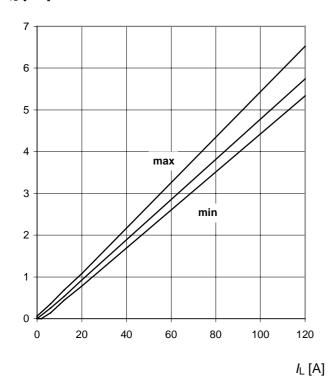
<sup>&</sup>lt;sup>23)</sup> Can be "switched off" by using a diode D<sub>S</sub> (see page 7) or leaving open the current sense output.



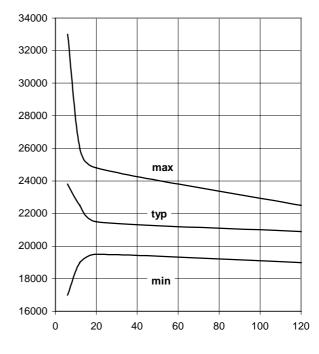
### **Characteristics**

#### **Current sense versus load current:**

 $I_{IS} = f(I_L)$  $I_{IS}$  [mA]



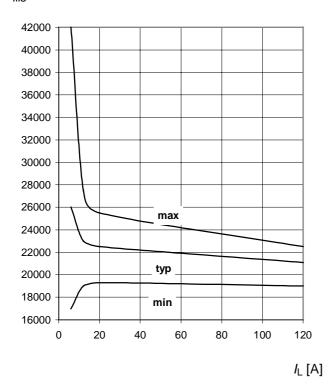
**Current sense ratio:**  $K_{ILIS} = f(I_L), T_J = 25 \text{ °C}$ *k*ilis



*I*∟ [A]

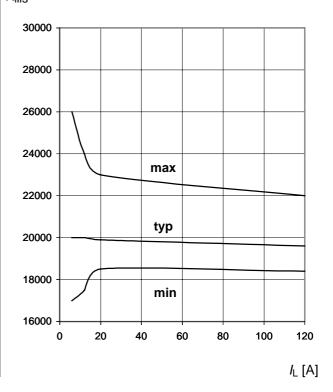
#### **Current sense ratio:**

$$K_{\text{ILIS}} = f(I_{\text{L}}), T_{\text{J}} = -40 \text{ °C}$$
  
 $K_{\text{illis}}$ 



#### **Current sense ratio:**

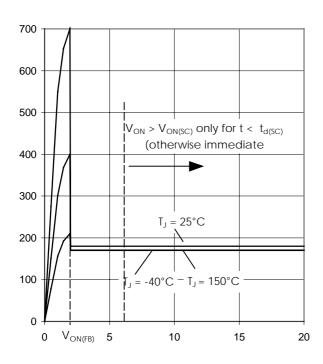
 $K_{ILIS} = f(I_L), T_J = 150 \, ^{\circ}C$ *K*ilis



### Typ. current limitation characteristic

 $I_L = f(V_{ON}, T_j)$ 

*I*∟ [A]

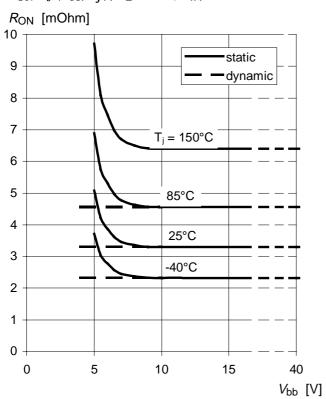


Von [V]

In case of  $V_{ON}$  >  $V_{ON(SC)}$  (typ. 6 V) the device will be switched off by internal short circuit detection.

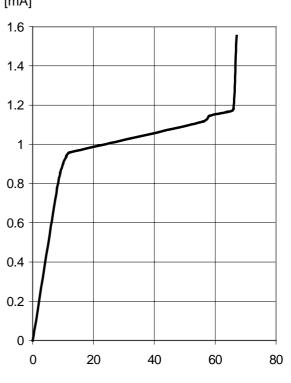
### Typ. on-state resistance

 $R_{ON} = f(V_{bb}, T_j); I_L = 20 \text{ A}; V_{IN} = 0$ 



Typ. input current  $I_{IN} = f(V_{DIN}), V_{DIN} = V_{DD} - V_{IN}$ 

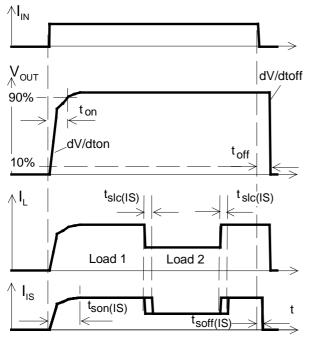
/<sub>IN</sub> [mA]



V<sub>bIN</sub> [V]

# **Timing diagrams**

**Figure 1a:** Switching a resistive load, change of load current in on-condition:



The sense signal is not valid during a settling time after turn-on/off and after change of load current.

Figure 2a: Switching motors and lamps:

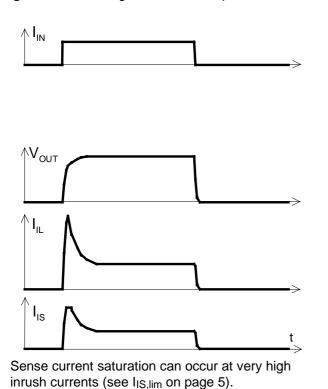


Figure 2b: Switching an inductive load:

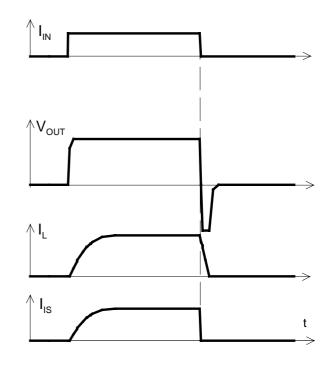
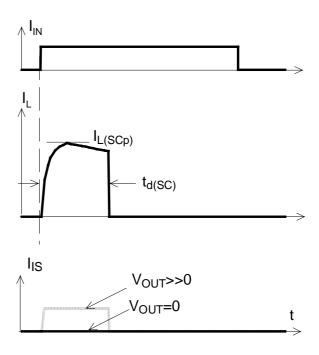


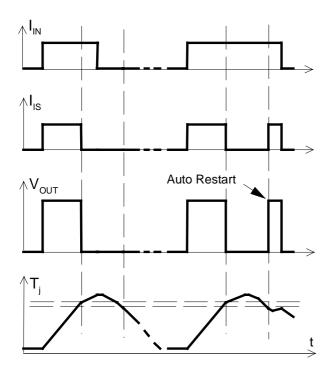
Figure 3a: Short circuit: shut down by short circuit detection, reset by  $I_{IN} = 0$ .



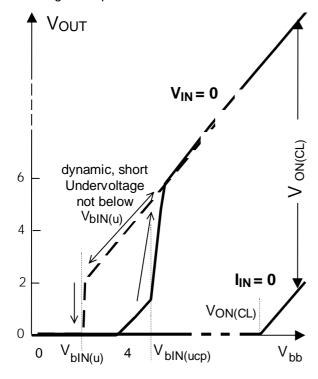
Shut down remains latched until next reset via input.



**Figure 4a:** Overtemperature Reset if  $T_i < T_{jt}$ 



**Figure 6a:** Undervoltage restart of charge pump, overvoltage clamp



## Preliminary Data Sheet BTS550P

# Package and Ordering Code

All dimensions in mm

### TO-218AB/5 Option E3146 Ordering code

E3146 Q67060-S6952A3

15
14.8
10.8
4.04
10.5
1.5
1.5
1.8
4.2.54=10.16
1) punch direction, burr max. 0.04

3) press burr max. 0.05

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